

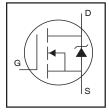
### **AUTOMOTIVE GRADE**

# AUIRLL024Z

HEXFET® Power MOSFET

#### **Features**

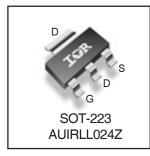
- Advanced Process Technology
- Ultra Low On-Resistance
- 150°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified \*



V <sub>(BR)DSS</sub>	55V	
R <sub>DS(on)</sub>	typ.	$48 m\Omega$
	max.	60m $Ω$
I <sub>D</sub>		5.0A

### **Description**

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low onresistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T<sub>A</sub>) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V ⑦	5.0	
I <sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V ⑦	4.0	Α
I <sub>DM</sub>	Pulsed Drain Current ①	40	
P <sub>D</sub> @T <sub>A</sub> = 25°C	Power Dissipation ②	2.8	
P <sub>D</sub> @T <sub>A</sub> = 25°C	Power Dissipation ®	1.0	W
	Linear Derating Factor ②	0.02	W/°C
$V_{GS}$	Gate-to-Source Voltage	± 16	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Thermally Limited) ②	21	mJ
E <sub>AS</sub> (tested )	Single Pulse Avalanche Energy Tested Value ®	38	
I <sub>AR</sub>	Avalanche Current ①	See Fig.12a, 12b, 15, 16	Α
E <sub>AR</sub>	Repetitive Avalanche Energy ©		mJ
$T_{J}$	Operating Junction and	-55 to + 150	
T <sub>STG</sub>	Storage Temperature Range		°C

### **Thermal Resistance**

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient (PCB mount, steady state) ⑦		45	°C/W
$R_{\theta JA}$	Junction-to-Ambient (PCB mount, steady state) ®		120	

HEXFET® is a registered trademark of International Rectifier.

<sup>\*</sup>Qualification standards can be found at http://www.irf.com/

### Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.049		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
			48	60		V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.0A ③
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			80	mΩ	$V_{GS} = 5.0V, I_D = 3.0A$ ③
				100		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.0A <sup>③</sup>
$V_{GS(th)}$	Gate Threshold Voltage	1.0		3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
gfs	Forward Transconductance	7.5			S	$V_{DS} = 25V, I_D = 3.0A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 55V, V_{GS} = 0V$
				250		$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			200	nA	V <sub>GS</sub> = 16V
	Gate-to-Source Reverse Leakage			-200		V <sub>GS</sub> = -16V

### Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$Q_g$	Total Gate Charge		7.0	11		I <sub>D</sub> = 3.0A
$Q_{gs}$	Gate-to-Source Charge		1.5		nC	$V_{DS} = 44V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		4.0		,	V <sub>GS</sub> = 5.0V ③
t <sub>d(on)</sub>	Turn-On Delay Time		8.6			$V_{DD} = 28V$
t <sub>r</sub>	Rise Time		33		ns	$I_{D} = 3.0A$
t <sub>d(off)</sub>	Turn-Off Delay Time		20			$R_G = 56 \Omega$
t <sub>f</sub>	Fall Time		15			V <sub>GS</sub> = 5.0V ③
C <sub>iss</sub>	Input Capacitance		380			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		66			$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		36		pF	f = 1.0MHz
C <sub>oss</sub>	Output Capacitance		220			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C <sub>oss</sub>	Output Capacitance		53		,	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C <sub>oss</sub> eff.	Effective Output Capacitance		93			$V_{GS} = 0V$ , $V_{DS} = 0V$ to 44V $\textcircled{4}$

### **Diode Characteristics**

	Parameter	Min.	Тур.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current			5.0		MOSFET symbol
	(Body Diode)				Α	showing the
I <sub>SM</sub>	Pulsed Source Current			40		integral reverse
	(Body Diode) ①					p-n junction diode.
$V_{SD}$	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$ , $I_S = 3.0A$ , $V_{GS} = 0V$ ③
t <sub>rr</sub>	Reverse Recovery Time		15	23	ns	$T_J = 25^{\circ}C$ , $I_F = 3.0A$ , $V_{DD} = 28V$
Q <sub>rr</sub>	Reverse Recovery Charge		9.1	14	nC	di/dt = 100A/μs ③
t <sub>on</sub>	Forward Turn-On Time	Intrinsi	c turn-or	time is	negligible	e (turn-on is dominated by LS+LD)

#### Notes:

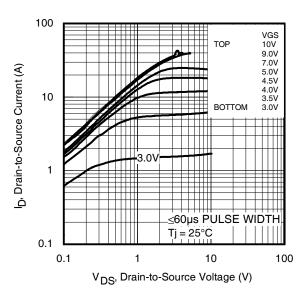
- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by  $T_{Jmax}$ , starting  $T_J = 25^{\circ}C$ , L = 4.8 mH  $R_G = 25\Omega$ ,  $I_{AS} = 3.0 A$ ,  $V_{GS} = 10 V$ . Part not recommended for use above this value.
- $\ \ \, \Phi \ \, C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- ® This value determined from sample failure population, starting T<sub>J</sub> = 25°C, L = 4.8mH, R<sub>G</sub> = 25 $\Omega$ , I<sub>AS</sub> = 3.0A, V<sub>GS</sub> =10V.
- When mounted on 1 inch square copper board.
- When mounted on FR-4 board using minimum recommended footprint.

# Qualification Information<sup>†</sup>

		ı					
		Automotive					
		(per AEC-Q101)					
Qualification Level		Comments: This part number(s) passed Automo qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automo level.					
Moisture Sensitivity	Level	SOT-223 MSL1					
	Machine Model	Class M1B (+/- 100V) <sup>††</sup>					
		AEC-Q101-002					
	Human Body Model	Class H0 (+/- 250V) <sup>††</sup>					
ESD		AEC-Q101-001					
	Charged Device Model	Class C5 (+/- 1125V) <sup>††</sup>					
		AEC-Q101-005					
RoHS Compliant	I	Yes					

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

<sup>††</sup> Highest passing voltage.



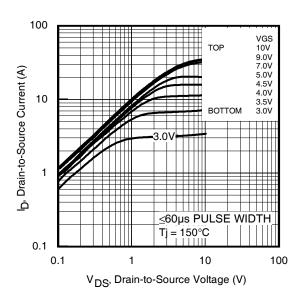
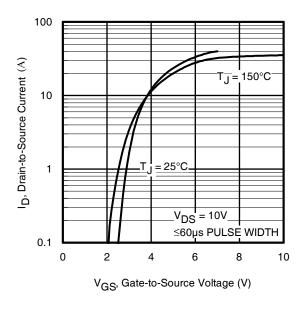


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



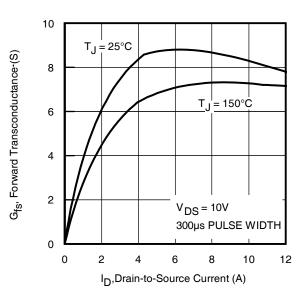
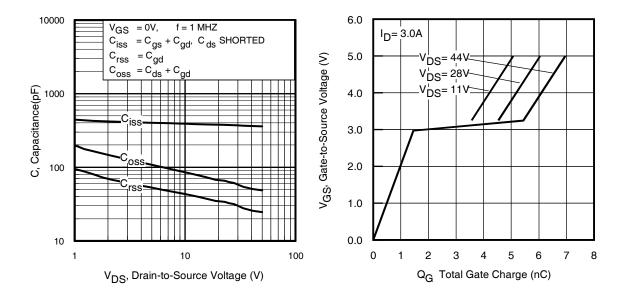


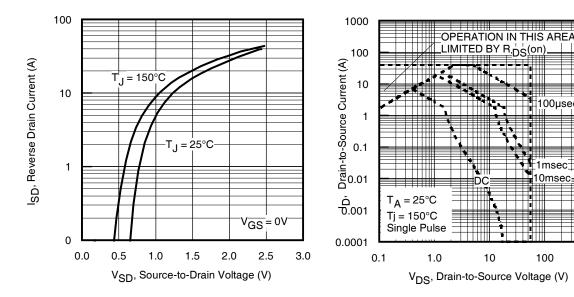
Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance vs. Drain Current



**Fig 5.** Typical Capacitance vs. Drain-to-Source Voltage

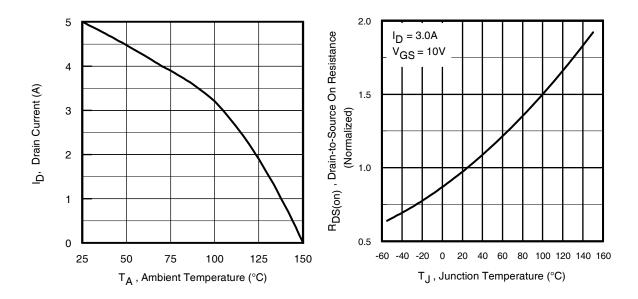
**Fig 6.** Typical Gate Charge vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

1000.0



**Fig 9.** Maximum Drain Current vs. Ambient Temperature

**Fig 10.** Normalized On-Resistance vs. Temperature

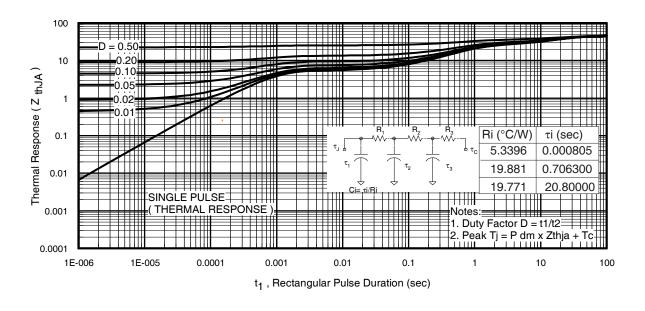


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

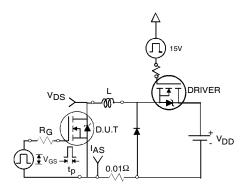


Fig 12a. Unclamped Inductive Test Circuit

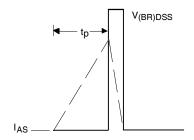


Fig 12b. Unclamped Inductive Waveforms

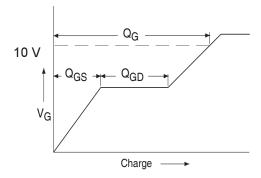
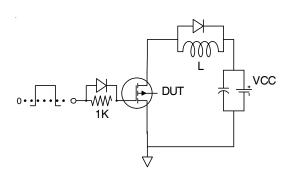


Fig 13a. Basic Gate Charge Waveform



100  $\mathsf{E}_{\mathsf{AS}}$  , Single Pulse Avalanche Energy (mJ) Ь TOP 3.0A 80 0.80A BOTTOM 0.69A 60 40 20 0 25 50 75 100 125 150 Starting  $T_J$ , Junction Temperature (°C)

Fig 12c. Maximum Avalanche Energy vs. Drain Current

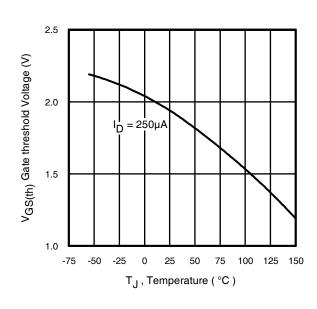


Fig 14. Threshold Voltage vs. Temperature

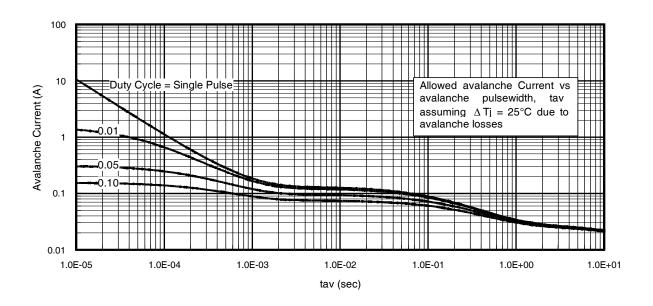
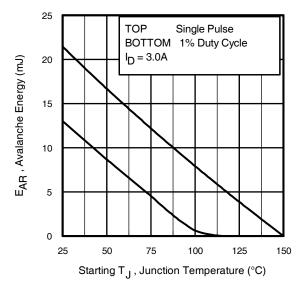


Fig 15. Typical Avalanche Current vs. Pulsewidth



# Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption:

  Duraly a thormal phaneman and
  - Purely a thermal phenomenon and failure occurs at a temperature far in excess of  $T_{jmax}$ . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long  $asT_{\mbox{\scriptsize jmax}}$  is not exceeded.
- Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. P<sub>D (ave)</sub> = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6.  $I_{av}$  = Allowable avalanche current.
- 7.  $\Delta T$  = Allowable rise in junction temperature, not to exceed  $T_{jmax}$  (assumed as 25°C in Figure 15, 16).
  - $t_{av}$  = Average time in avalanche.
  - D = Duty cycle in avalanche =  $t_{av} \cdot f$

 $Z_{thJC}(D, t_{av})$  = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ ( } 1.3 \cdot \text{BV} \cdot \text{I}_{aV} \text{)} = \triangle \text{T/ } Z_{thJC} \\ I_{av} &= 2\triangle \text{T/ [ } 1.3 \cdot \text{BV} \cdot Z_{th} \text{]} \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$

**Fig 16.** Maximum Avalanche Energy vs. Temperature

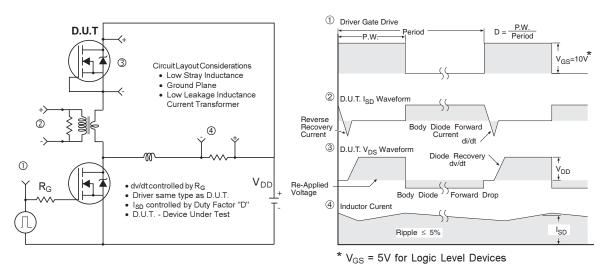


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

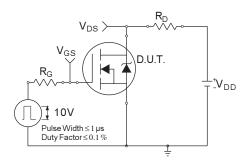


Fig 18a. Switching Time Test Circuit

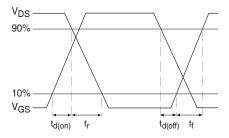
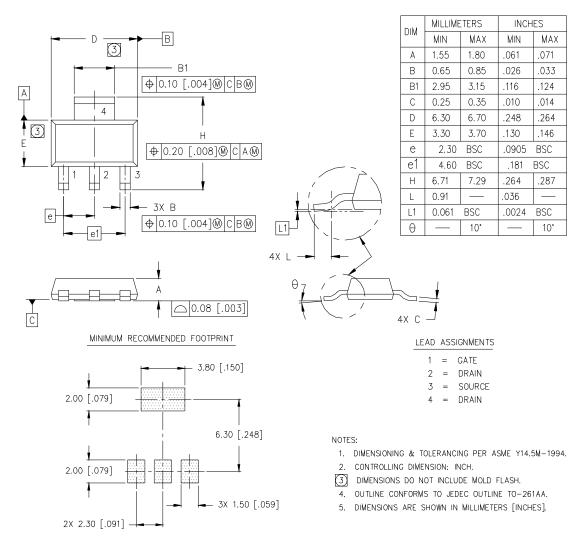


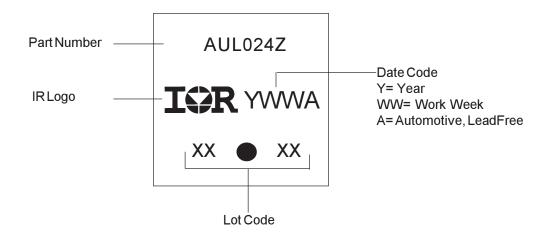
Fig 18b. Switching Time Waveforms

### SOT-223 (TO-261AA) Package Outline

Dimensions are shown in milimeters (inches)



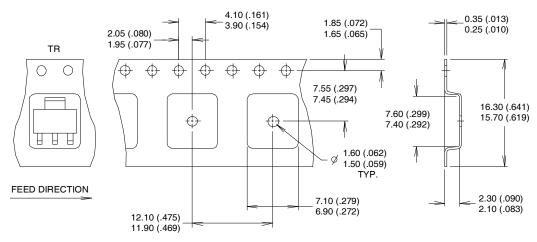
## SOT-223 (TO-261AA) Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

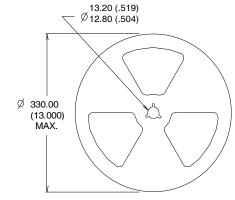
# SOT-223 (TO-261AA) Tape & Reel Information

Dimensions are shown in milimeters (inches)



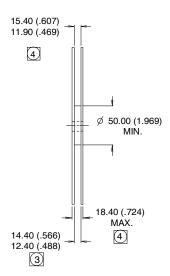
#### NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.
- 3. EACH Ø330.00 (13.00) REEL CONTAINS 2,500 DEVICES.



### NOTES:

- 1. OUTLINE COMFORMS TO EIA-418-1.
- 2. CONTROLLING DIMENSION: MILLIMETER...
- DIMENSION MEASURED @ HUB.
- INCLUDES FLANGE DISTORTION @ OUTER EDGE.



# Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRLL024Z	SOT-223	Tube	95	AUIRLL024Z
		Tape and Reel	2500	AUIRLL024ZTR

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